

CSP

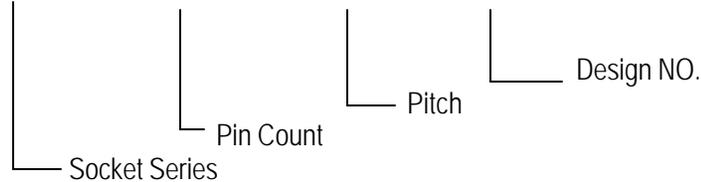
CHIP SIZE PACKAGE

Applicable IC/CSP

Open Top Surface Mount Type Micro Coil Spring Socket

ORDERING PROCEDURE

OTB/OTL - () - () - ()



SPECIFICATIONS

- Contact resistance: Initial 500m Ω (At 10mA)
- Maximum voltage: AC300V RMS (for 1 minute)
- Insulation resistance: 1,000M Ω or higher (At DC 500V)
- Rated current: 0.5A
- Insertion: Min. 10,000 cycle (Mechanical)

MATERIAL

- Body: PEI, PES
- Contact: BeCu, Au plating (Ni-base)



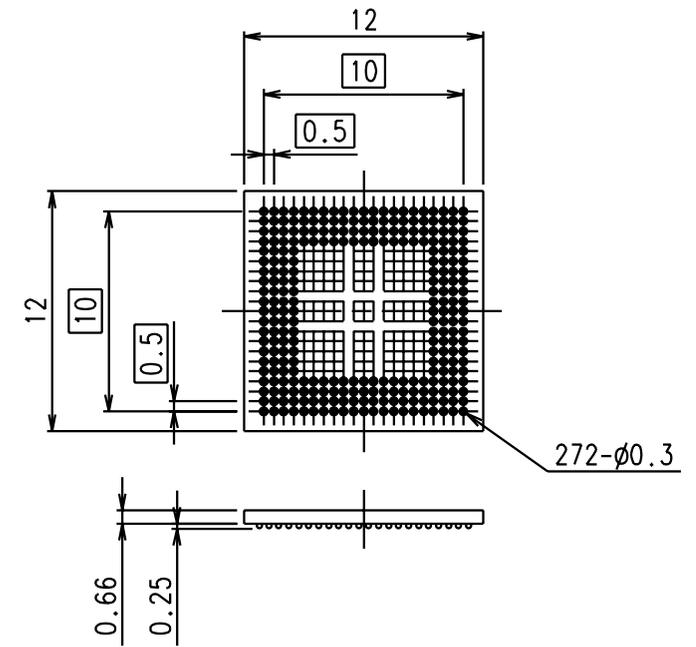
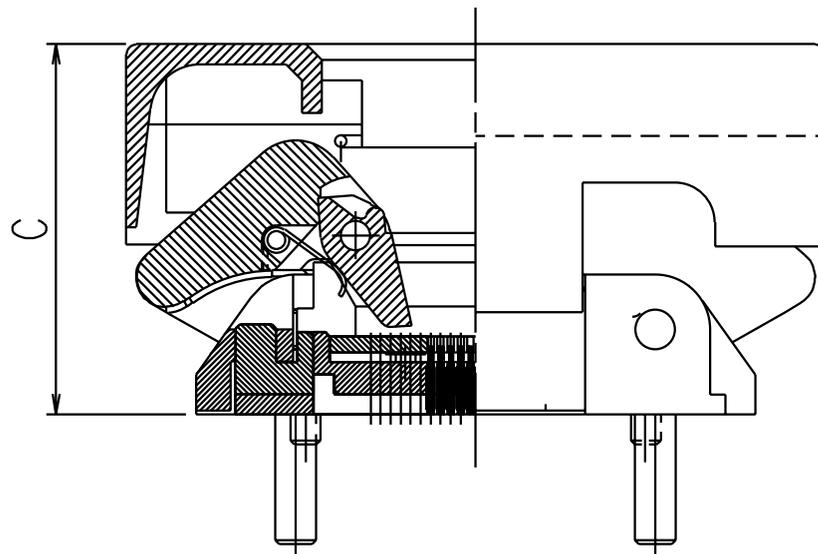
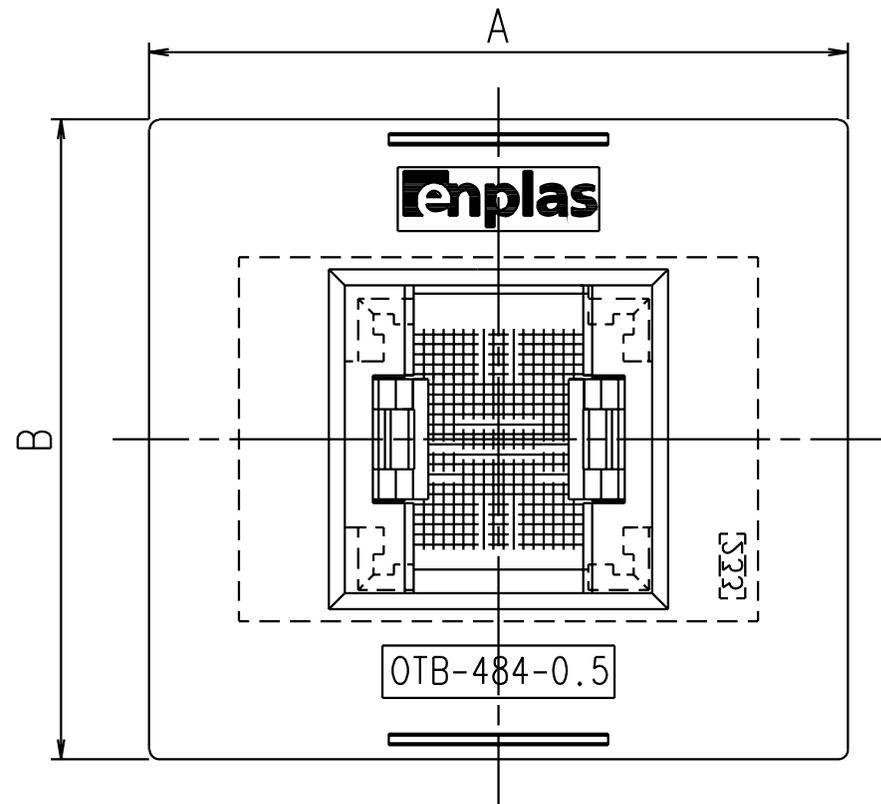
APPLICABLE IC DIMENSIONS & SOCKET DIMENSIONS

OTB-484 SERIES (0.5mm PITCH)

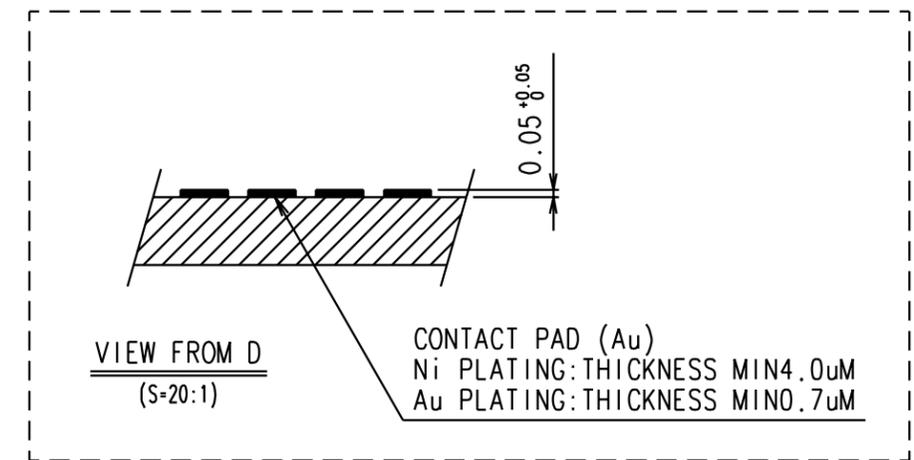
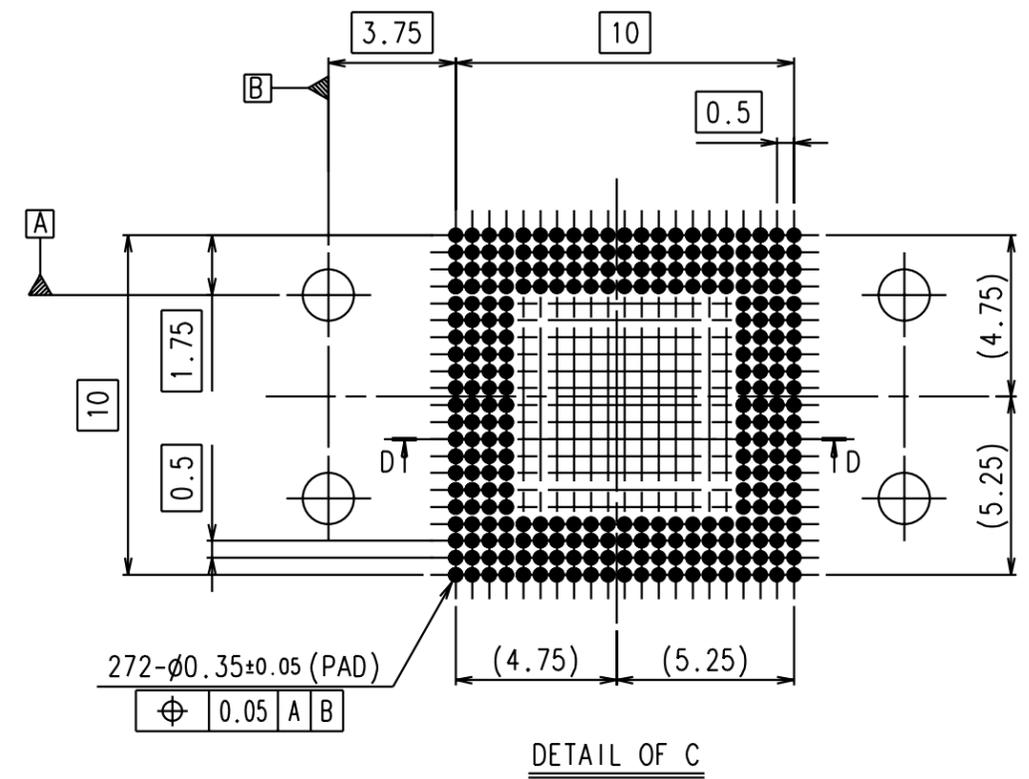
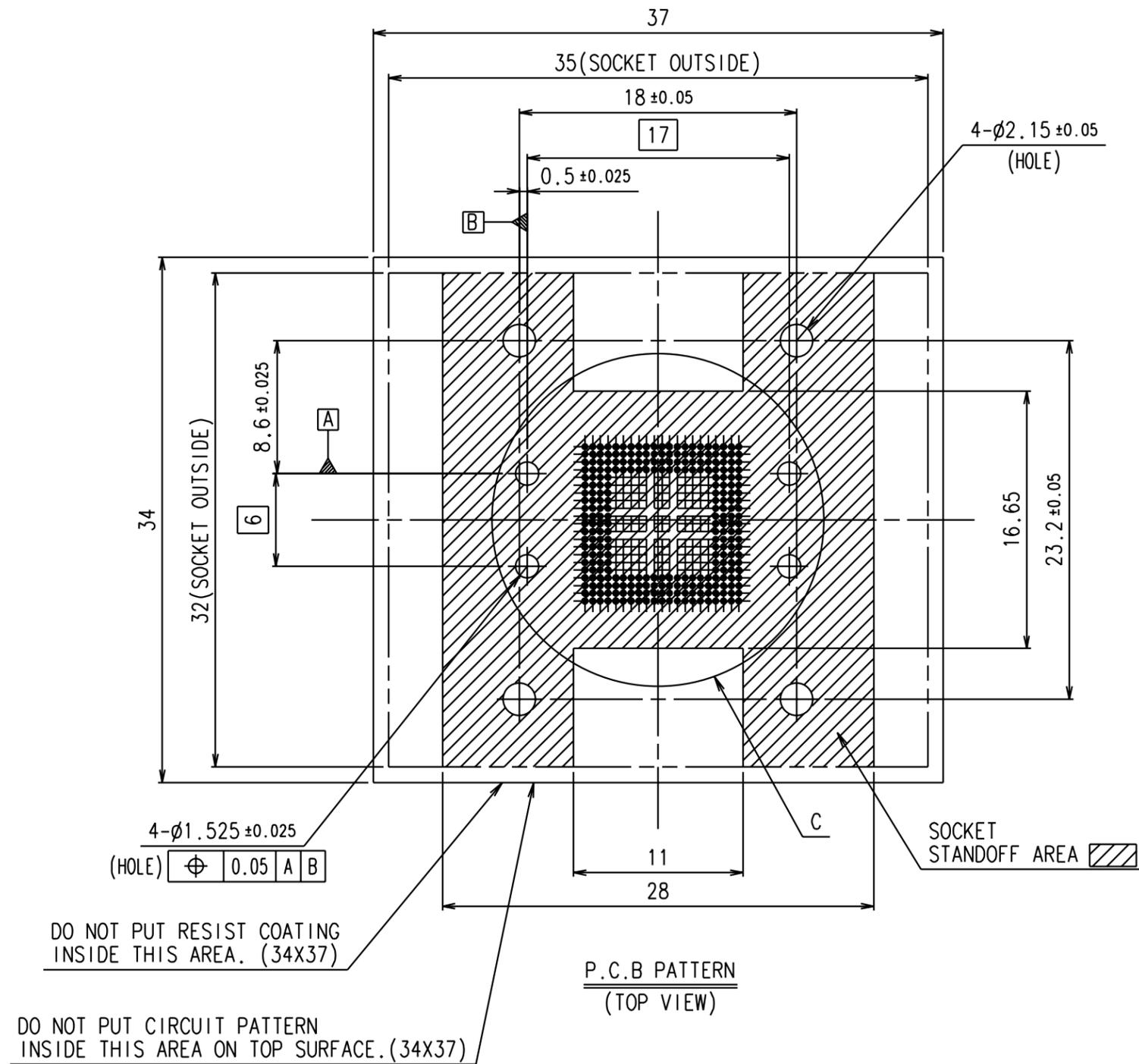
Unit: mm

PART NO.	APPLICABLE IC DIMENSIONS (REF.)					OUTSIDE DIMENSIONS (REF.)			REMARKS
	BODY SIZE	GRID	ROW/ARRAY	LEADS NUMBER	PITCH	A	B	C	
OTB-84(484)-0.5-14	7X7	12X12	Depopulated	84	0.5	35	32	18.5	
OTB-108(484)-0.5-09	8X8	14X14	Depopulated	108	0.5	35	32	18.5	
OTB-244(484)-0.5-06	12X12	21X21	Depopulated	244	0.5	35	32	18.5	
OTB-280(484)-0.5-10	11X11	19X19	Depopulated	280	0.5	35	32	18.5	
OTB-289(484)-0.5-06	12X12	21X21	Depopulated	289	0.5	35	32	18.5	

? Max. 12X12mm Package can be accommodated



MATCHING DEVICE
(REFERENCE ONLY)



OTB-272(484)-0.5
(REFERENCE ONLY)